

FEATURES

- Meets or Exceeds the Requirements of IBM® 360/370 Input/Output Interface Specification for 4.5-Mb/s Operation
- Single 5-V Supply
- Uncommitted Emitter-Follower Output Structure for Party-Line Operation
- Driver Output Short-Circuit Protection
- Driver Input/Receiver Output Compatible With TTL
- Receiver Input Resistance . . . 7.4 kΩ to 20 kΩ
- Ratio Specification for Propagation Delay Time, Low to High/High to Low

DESCRIPTION/ ORDERING INFORMATION

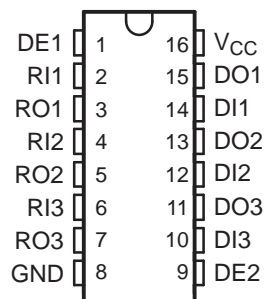
The SN751730 triple line driver/receiver is specifically designed to meet the input/output interface specifications for IBM System 360/370. It also is compatible with standard TTL logic and supply voltage levels.

The low-impedance emitter-follower driver outputs of the SN751730 drive terminated lines, such as coaxial cable or twisted pair. Having the outputs uncommitted allows wired-OR logic to be performed in party-line applications. Output short-circuit protection is provided by an internal clamping network that turns on when the output voltage drops below approximately 2.5 V.

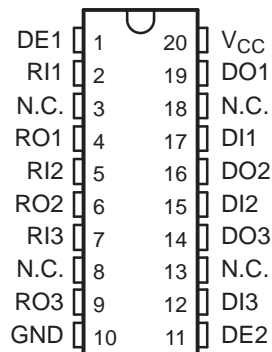
An open line affects the receiver input as does a low-level input voltage.

All the driver inputs and receiver outputs are in conventional TTL configuration and the gating can be used during power-up and power-down sequences to ensure that no noise is introduced to the line by pulling either DE1 or DE2 to a low level.

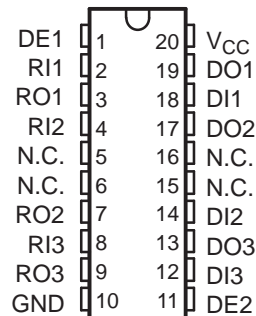
D OR N PACKAGE
(TOP VIEW)



DW PACKAGE
(TOP VIEW)



NS PACKAGE
(TOP VIEW)



N.C. – No internal connection



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ORDERING INFORMATION

T _A	PACKAGE ⁽¹⁾⁽²⁾		ORDERABLE PART NUMBER	TOP-SIDE MARKING
0°C to 70°C	PDIP – N	Tube	SN751730N	SN751730N
	SOIC – D	Tube	SN751730D	SN751730
		Tape and reel	SN751730DR	
	SOIC – DW	Tube	SN751730DW	SN751730
		Tape and reel	SN751730DWR	
	SOP – NS	Tape and reel	SN751730NSR	SN751730

- (1) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.
(2) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.

FUNCTION TABLES

EACH DRIVER

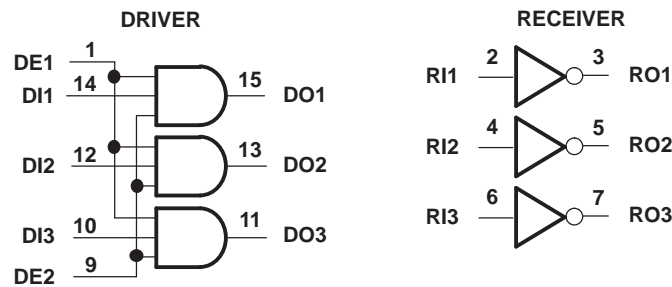
INPUTS			OUTPUT DO
DI	DE1	DE2	
L	X	X	L
X	L	X	L
X	X	L	L
H	H	H	H

EACH DRIVER⁽¹⁾

INPUT RI	OUTPUT RO
L	H
H	L
Open	H

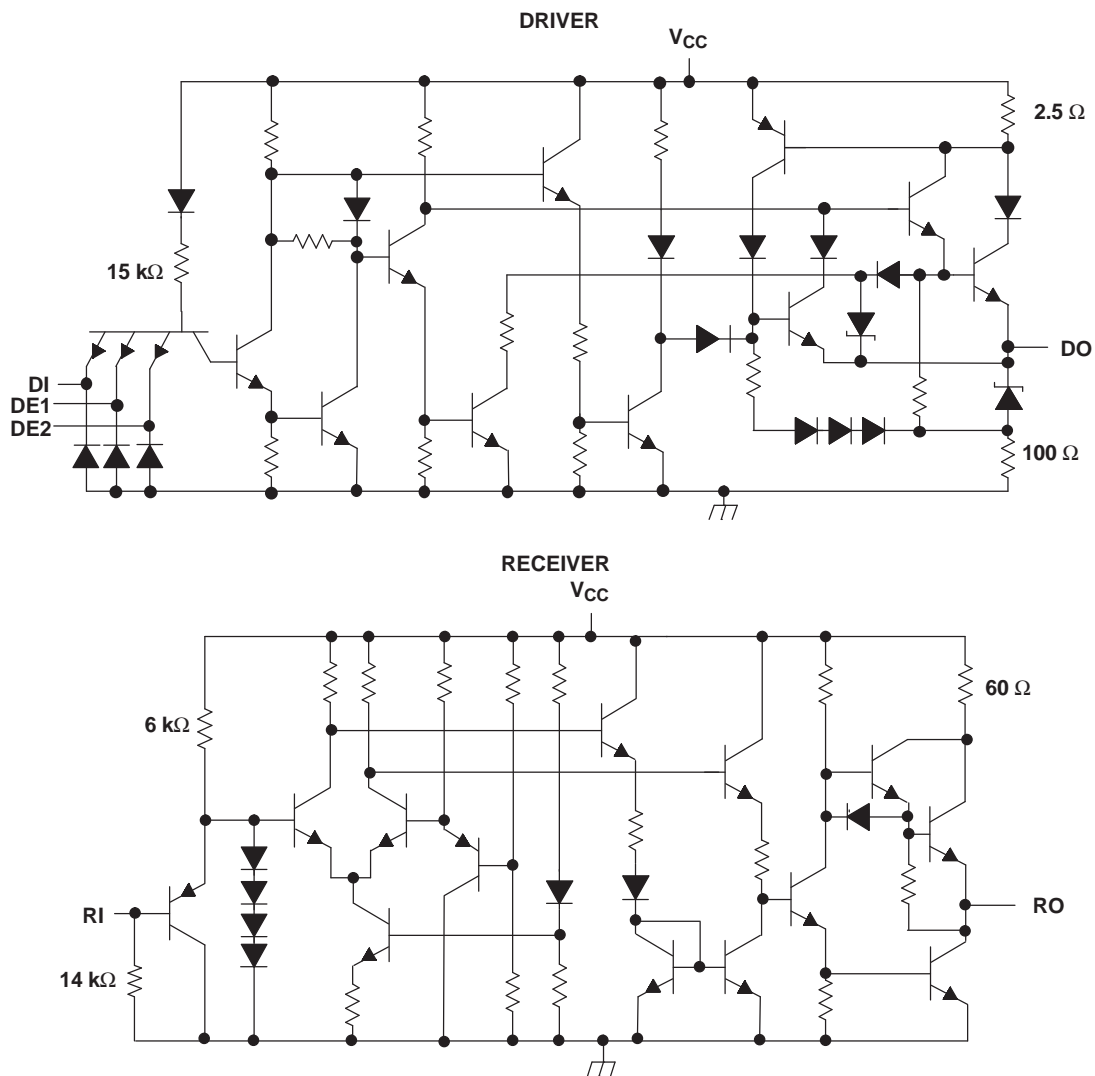
- (1) H = high level, L = low level, X = irrelevant

LOGIC DIAGRAM (POSITIVE LOGIC)



Pin numbers shown are for the D and N package only.

EQUIVALENT SCHEMATICS OF DRIVER AND RECEIVER⁽¹⁾



(1) All resistor values are nominal.

SN751730 TRIPLE LINE DRIVER/RECEIVER

SLLS062E – MAY 1990 – REVISED AUGUST 2007

Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT	
V _{CC}	Supply voltage ⁽²⁾		7	V	
V _I	Input voltage range	Driver	-0.5	7	V
		Receiver	-0.5	7	V
V _O	Output voltage range	Driver	-0.5	7	V
	Enable input voltage range		-0.5	7	V
θ _{JA}	Package thermal impedance ⁽³⁾	D package		73	°C/W
		DW package		58	
		N package		67	
		NS package		60	
T _J	Operating virtual junction temperature		150	°C	
	Lead temperature 1,6 mm (1/16 inch) from case for 10 s		260	°C	
T _{stg}	Storage temperature range	-65	150	°C/W	

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values are with respect to network ground terminal.
- (3) The package thermal impedance is calculated in accordance with JESD 51-7.

Recommended Operating Conditions

		MIN	NOM	MAX	UNIT
V _{CC}	Supply voltage	4.75	5	5.25	V
V _{IH}	High-level input voltage	Driver, Enable	2		V
		Receiver	1.55		
V _{IL}	Low-level input voltage	Driver, Enable		0.8	V
		Receiver		1.15	
T _A	Operating free-air temperature	0		70	°C

DRIVER SECTION

Electrical Characteristics

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	MAX	UNIT
V_{IK}	Input clamp voltage	$V_{CC} = 4.75 \text{ V}$,	$I_{IL} = -18 \text{ mA}$		-1.5	V
V_{OH}	High-level output voltage	$V_{CC} = 4.75 \text{ V}$,	$V_{IH} = 2 \text{ V}$,	3.11		V
		$I_{OH} = -59.3 \text{ mA}$	$T_A = 25^\circ\text{C}$			
		$V_{CC} = 5.25 \text{ V}$,	$V_{IH} = 2 \text{ V}$,		4.1	
		$I_{OH} = -78.1 \text{ mA}$				
		$V_{CC} = 4.75 \text{ V}$,	$V_{IH} = 2 \text{ V}$,	3.05		
		$R_L = 51.4 \Omega$				
		$V_{CC} = 5.25 \text{ V}$,	$V_{IH} = 2 \text{ V}$,		4.2	
		$R_L = 56.9 \Omega$				
V_{ODH}	Differential high-level output voltage	$R_L = 46.3 \Omega$ or 56.9Ω			0.5	V
V_{OL}	Low-level output voltage	$V_{CC} = 5.25 \text{ V}$,	$I_{OL} = -0.24 \text{ mA}$		0.15	V
			$V_{IL} = 0.8 \text{ V}$,	$R_L = 56.9 \Omega$		
		$V_{IH} = 4.5 \text{ V}$				
I_{IH}	High-level input current	$V_{CC} = 5.25 \text{ V}$,	$V_{IH} = 2.7 \text{ V}$		20	μA
				DE	60	
I_{IL}	Low-level input current	$V_{CC} = 5.25 \text{ V}$,	$V_{IH} = 0.4 \text{ V}$		-400	μA
				DE	-1200	
I_{OH}	High-level output current	$V_{CC} = 4.75 \text{ V}$,	$V_{IL} = 0$		100	μA
		$V_{OH} = 5 \text{ V}$	$V_{IH} = 4.5 \text{ V}$		100	
I_{OS}	Short-circuit output current ⁽¹⁾	$V_{CC} = 5.25 \text{ V}$	$V_{IH} = 4.5 \text{ V}$		-30	mA
I_{CCH}	Supply current (total package)	$V_{CC} = 5.25 \text{ V}$,	$V_{I(D)} = 4.5 \text{ V}$,		47	mA
I_{CCL}			$V_{I(R)} = 0$			
		No load	$V_{I(D)} = 0$,		80	
			$V_{I(R)} = 4.5 \text{ V}$			

(1) Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

Switching Characteristics

$V_{CC} = 5 \text{ V} + 5\%$, $T_A = 25^\circ\text{C}$

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
t_{PLH}	Propagation delay time, low- to high-level output	$R_L = 47.5 \Omega$,	See Figure 1	6.5	12	18.5	ns
t_{PHL}	Propagation delay time, high- to low-level output			6.5	12	18.5	ns
Δt_{pd}	Differential propagation delay time ⁽¹⁾					10	ns
t_r	Output rise time	$V_{CC} = 5 \text{ V}$,	$V_O = 0.15 \text{ V}$ to 3.05 V ,	5	10		ns
		$R_L = 47.5 \Omega$,	V_i				
t_f	Output fall time	See Figure 1	$C_L = 10.2 \text{ pF}$,	5	13		ns
SR	Slew rate	$V_O = 1 \text{ V}$ to 3 V average, $R_L = 47.5 \Omega$,	$C_L = 10.2 \text{ pF}$,			0.65	V/ns
		See Figure 1					

(1) $\Delta t_{pd} = |t_{PLH} - t_{PHL}|$

RECEIVER SECTION

Electrical Characteristics

over operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	MAX	UNIT
V_{OH}	High-level output voltage	$V_{CC} = 4.75\text{ V}$, $I_{OH} = -400\ \mu\text{A}$	$V_I = 1.15\text{ V}$,	2.7		V
V_{OL}	Low-level output voltage	$V_{CC} = 4.75\text{ V}$, $V_{IH} = 1.55\text{ V}$	$I_{OL} = 8\text{ mA}$		0.5	V
			$I_{OL} = 4\text{ mA}$		0.4	
r_i	Input resistance	$V_{CC} = 0$,	$V_I = 0.15\text{ V to }3.9\text{ V}$	7.4	20	k Ω
I_{IH}	High-level input current	$V_{CC} = 4.75\text{ V}$,	$V_{IH} = 3.11\text{ V}$		0.42	mA
I_{IL}	Low-level input current	$V_{CC} = 5.25\text{ V}$,	$V_{IL} = 0.15\text{ V}$	-0.24	0.04	mA
$I_{OS}^{(1)}$	Short-circuit output current	$V_{CC} = 5.25\text{ V}$,	$V_{IL} = 0$	-20	-100	mA
I_{CCH}	Supply current (total package)	$V_{CC} = 5.25\text{ V}$, No load	$V_{I(D)} = 4.5\text{ V}$, $V_{I(R)} = 0$		47	mA
I_{CCL}			$V_{I(D)} = 0$, $V_{I(R)} = 4.5\text{ V}$		80	

(1) Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

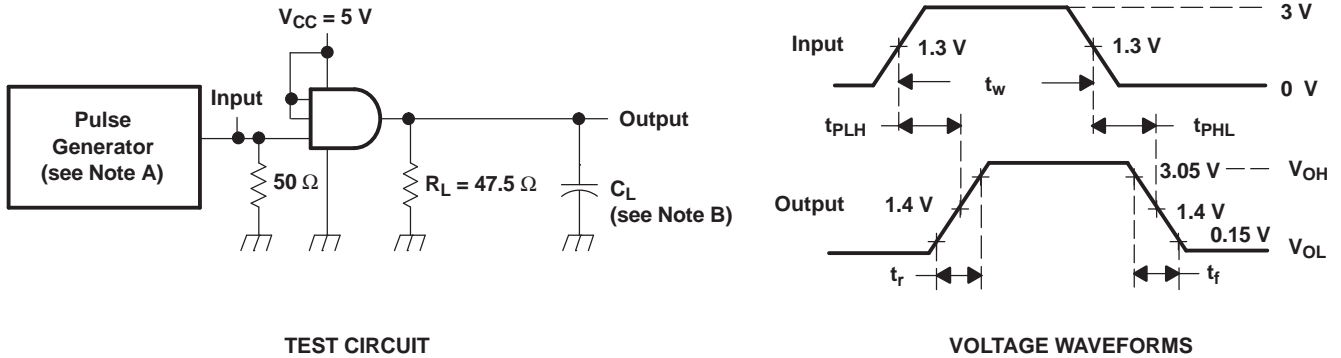
Switching Characteristics

$V_{CC} = 5\text{ V} + 5\%$, $T_A = 25^\circ\text{C}$

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	Propagation delay time, low- to high-level output	$R_L = 2\text{ k}\Omega$, $C_L = 15\text{ pF}$, See Figure 2	7.5	12	19.5	ns
t_{PHL}	Propagation delay time, high- to low-level output		7.5	12	19.5	ns
$\Delta t_{pd}^{(1)}$	Differential propagation delay time				10	ns

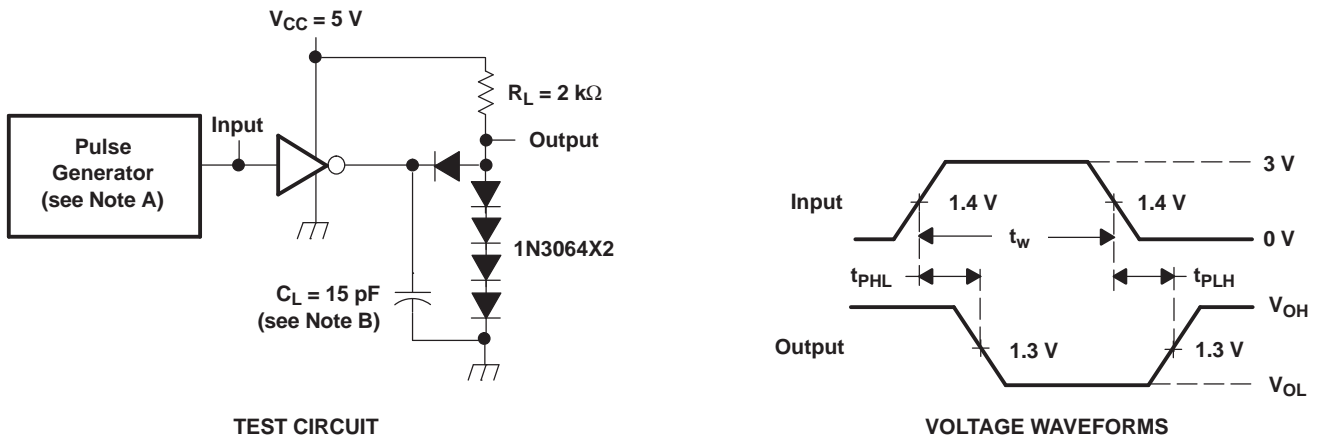
(1) $\Delta t_{pd} = |t_{PLH} - t_{PHL}|$

PARAMETER MEASUREMENT INFORMATION



NOTES: A. The pulse generator has the following characteristics: $Z_O \approx 50 \Omega$, $t_w \leq 500$ ns, $PRR \leq 1$ MHz, $t_f \leq 6$ ns, $t_r \leq 15$ ns.
B. C_L includes probe and jig capacitance.

Figure 1. Driver Test Circuit and Voltage Waveforms



NOTES: A. The pulse generator has the following characteristics: $Z_O \approx 50 \Omega$, $t_w \leq 500$ ns, $PRR \leq 1$ MHz, $t_f \leq 10$ ns, $t_r \leq 10$ ns.
B. C_L includes probe and jig capacitance.

Figure 2. Receiver Test Circuit and Voltage Waveforms

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN751730DW	LIFEBUY	SOIC	DW	20	25	RoHS & Green	NIPDAU	Level-1-260C-UNLIM		SN751730	

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSELETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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TUBE


*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
SN751730DW	DW	SOIC	20	25	507	12.83	5080	6.6

DW0020A



PACKAGE OUTLINE

SOIC - 2.65 mm max height

SOIC



4220724/A 05/2016

NOTES:

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
5. Reference JEDEC registration MS-013.

EXAMPLE BOARD LAYOUT

DW0020A

SOIC - 2.65 mm max height

SOIC



LAND PATTERN EXAMPLE
SCALE:6X



SOLDER MASK DETAILS

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NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DW0020A

SOIC - 2.65 mm max height

SOIC



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:6X

4220724/A 05/2016

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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